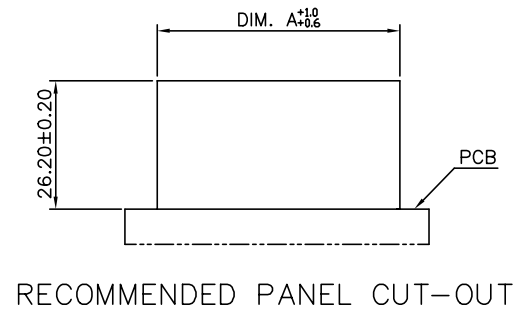
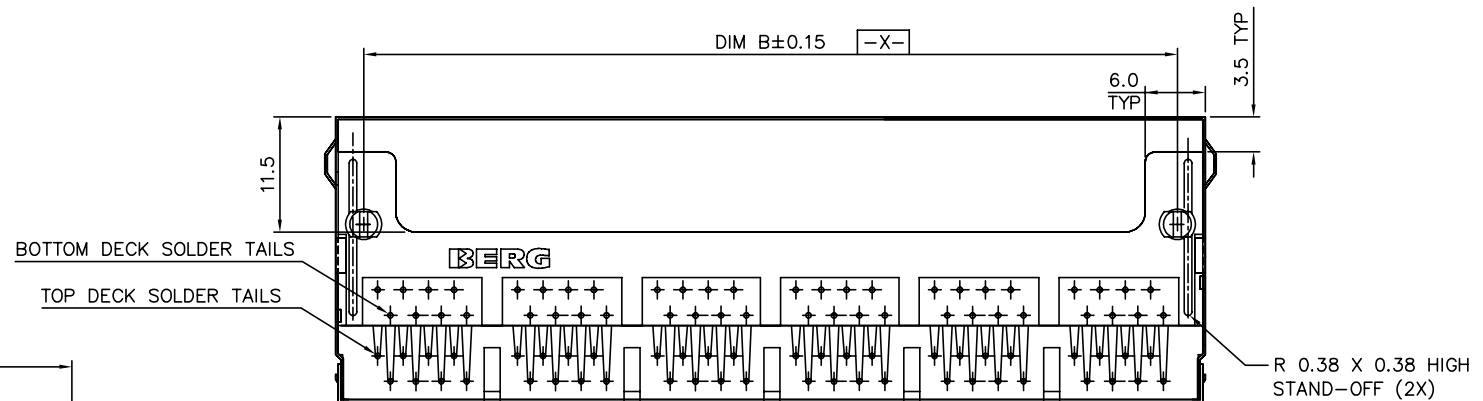
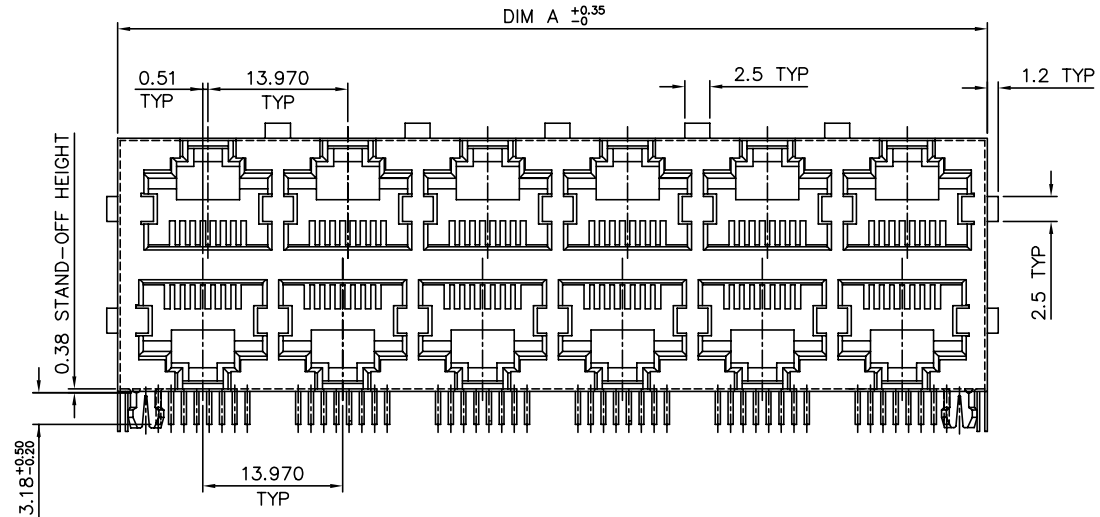
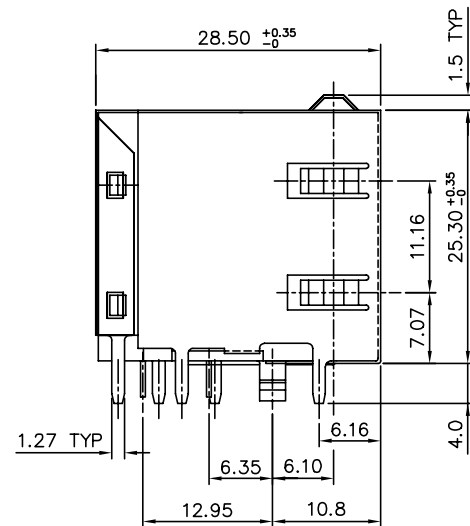


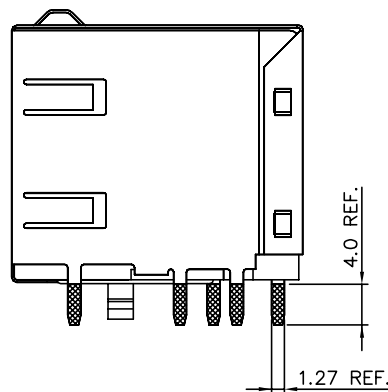
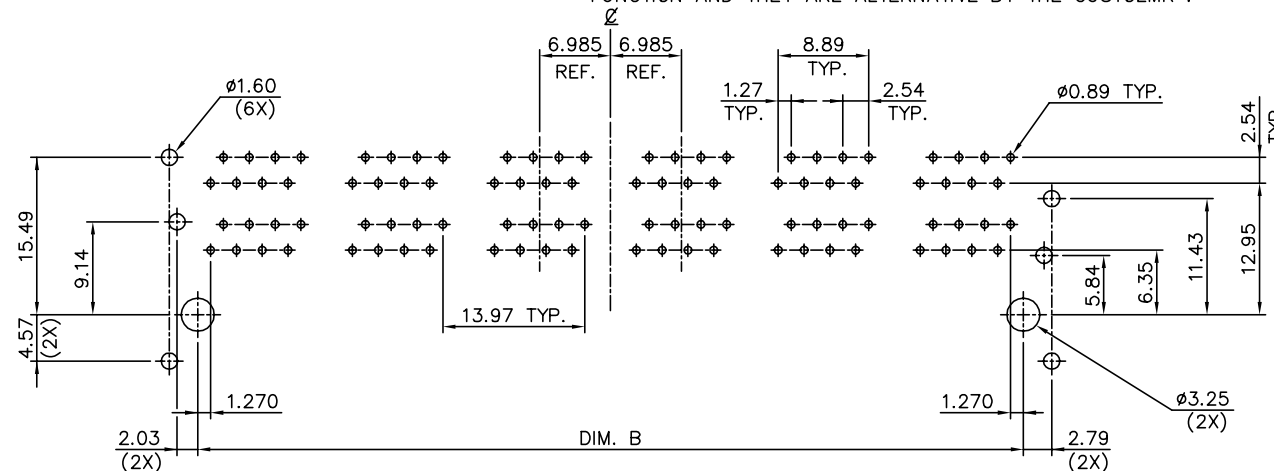


mat'l. code				surface ISD1302 ✓		tolerance ISD1101 ISD406		projection 		product family MOD JACK			
ltn ecn nldr				date		tolerances unless other		wisely specified		title			
F	T03-0443	WL	10/06/03	angle linear	0.X±0.3				RJ45 DOUBLE DECK GANG JACK ASSY				
G	N05-0018	YS	01/25/05		0.XX±0.15								
H	N08-0100	SH	09/25/08		0'±2' 0.XXX±0.05								
J	N08-0273	SH MMQ	12/25/08	dr	CATHY LIN	05/26/98			dwg no		sheet 1 of 2	size	
K	ELX-N-010710	SH MMQ	3/14/12	engr	TONY CHIEN	05/26/98			74633		A4		
				chr	TONY CHIEN	05/26/98							
				appd	JENN TSAO	05/26/98			type		Product Customer Drawing		
sheet		revision		nk									
index		sheet		1 2									

PRODUCT NO.	PORT NUMBERS	DIM.A±0.35 mm	DIM.B±0.15 mm	PACKAGING	REMARKS	PLATING
74633-004-R 74633-004-RLF 74633-004-RHLF	4x2	58.92	53.34	USING TRAY	AVAILABLE	5u" Au + high performance lubricant
74633-304-R 74633-304-RLF 74633-304-RHLF						5u" Au + high performance lubricant
74633-504-R 74633-504-RLF 74633-504-RHLF						50 u" GXT

LEAD FREE PRODUCT NO.

MEETS PIP PROCESS PRODUCT NO.

DETAIL C
NOTE 4RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE

mat'l. code			surface ISO1302	tolerance ISO1101 ISO406	projection mm	product family MOD JACK		
l	tr	ec	n	o	d	r	date	
F	T03-0443	WL	10/06/03	angle	0.1	0.1	date	
G	N05-0018	YS	01/25/05	0°±2'	0.1	0.1	date	
H	N08-0100	SH	09/25/08	0.1	0.1	0.1	date	
J	N08-0273	SH	12/25/08	dr	CATHY LIN	05/26/98	date	
K	ELX-N-010710	SH	MMO 3/14/12	engr	TONY CHIEN	05/26/98	date	
				chr	TONY CHIEN	05/26/98	date	
				appd	JENN TSAO	05/26/98	date	
sheet	revision						dwg no	sheet2 of 2
index	sheet						74633	A4
							type	Product Customer Drawing

NOTES:

- RECOMMENDED P.C.B THICKNESS 1.60 MM
- HOUSING MAT'L: NYLON 6/6, 25% G.F., UL 94V-0, COLOR - BLACK.
- CONTACTS: PHOS BRONZE ALLOY UNS-C51000, Ø 0.460 ROUND WIRE, PLATING SEE TABLE.
- SHIELDING MATERIAL: 0.25MM THICK, BRASS ALLOY. SHIELDING PLATING: 30u" NICKEL PRE-PLATED AND WITH POST SOLDER DIP ON GROUNDING LEGS AS DETAIL C (IF LF P/N WITH POST PURE TIN SOLDER DIP).
- IF LF P/N THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
- IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION.
- EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOEMR.